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EVOLUTION OF AN a-Si:H/a-Ge:H SUPERLATTICE**

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RAMAN STUDY OF THE ANNEALING-INDUCED STRUCTURAL EVOLUTION OF AN a-Si:H/a-Ge:H SUPERLATTICE

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Raman scattering was used to follow the structural and layer-composition changes which accompany annealing of an a-Si:H/a-Ge:H superlattice. Following significant intermixing in the amorphous phase, two separate crystallization events are resolved: sudden crystallization of the Ge-rich layers followed by gradual crystallization of the Si-rich layers. Ultimately, compositional homogenization occurs.

1. Introduction

This paper presents a Raman-scattering study of the structural changes accompanying annealing in an a-Si:H/a-Ge:H superlattice. While the structural evolution in this system is complex, Raman scattering is effective for distinguishing among the various phases.^{1,2,3} Recent Raman work on crystalline Si_{1-x}Ge_x alloys^{4,5} allows this technique to be used to determine composition (x) in the crystallized layers, and recent diffusion studies⁶ of amorphous Si/Ge multilayers are also available for comparison to our Raman results.

2. Experiment

The investigated superlattice was prepared by PECVD techniques described elsewhere.⁷ The intended structure consisted of thirty cycles of a-Si:H (sublayer thickness $d_{Si}=30$ nm) alternating with a-Ge:H (sublayer thickness $d_{Ge}=5.5$ nm). The top layer was a-Si:H, with the bottom a-Ge:H sublayer on a 69 nm a-Si:H buffer layer deposited on a c-Si substrate. The deposition plasma was halted between layers to achieve abrupt interfaces. Rutherford backscattering confirmed the superlattice structure. Furnace anneals were done in air for 20-minute periods.

Raman measurements were carried out in a back-scattering configuration⁸ using the 1.916 eV red line of a Kr laser. For back scattering, $1/(2\alpha)$ is a conservative measure of the optical penetration depth d_{opt} . At 1.916 eV, d_{opt} values estimated from the relevant

absorption coefficients α yield $(d_{\text{opt}}/d_{\text{Si}})=15$ for a-Si:H and 50 for c-Si, $(d_{\text{opt}}/d_{\text{Ge}})=4$ for a-Ge:H and 7 for c-Ge. Thus several near-surface cycles (to a depth of about 150 nm) are probed in these experiments, the thinner but more absorptive Ge layers being the limiting factor.⁹ Laser power was kept below 10 mW, and a spectral slit width of 4 cm^{-1} was used. Long scanning times (15 to 90 hours) were needed to yield clean spectra.

3. Results: Amorphous Interdiffusion and Two Crystallizations

Figure 1 presents our results. The annealing sequence begins with the as-grown a-Si:H/a-Ge:H multilayer and ends with a homogeneous crystalline alloy. Table 1 lists the peak positions and observed linewidths (full width at half maximum) estimated by deconvoluting these spectra.

A 400 C anneal (not shown), like the unannealed sample, revealed only the two broad bands corresponding to the dominant bands of a-Ge:H (272 cm^{-1}) and a-Si:H (477 cm^{-1}). But at 525 C, a third broad band appears which corresponds to a-Si_{1-x}Ge_x:H alloys.¹ Using the $x=0.45$ Raman spectrum reported in Ref. 1, the relative Si-Ge and Ge-Ge intensities observed for the 525 C anneal,¹⁰ and a simple model assuming a-Si:H/a-Si_{0.5}Ge_{0.5}:H/a-Ge:H in place of a graded interface, we estimate that the alloyed regions contain 30% of the Ge atoms. This corresponds to an interface-alloy thickness of 1.6 nm. This can be compared to the equivalent diffusion-determined thickness given by $L^2=(16/\pi)Dt$, using $D=1.0 \times 10^{-3} (\text{nm})^2\text{s}^{-1}$ extrapolated from Ref. 6. This calculation yields $L=2.5 \text{ nm}$, in quite reasonable agreement with our Raman-derived experimental result.

The 600 C anneal is noteworthy because the Ge-rich layers have crystallized while the Si-rich layers remain predominantly amorphous. A weak c-Si peak is, however, already present, superimposed on the a-Si band, as seen in Fig. 1 and listed in Table 1. Table 1 includes composition estimates for the crystalline phases, obtained from:

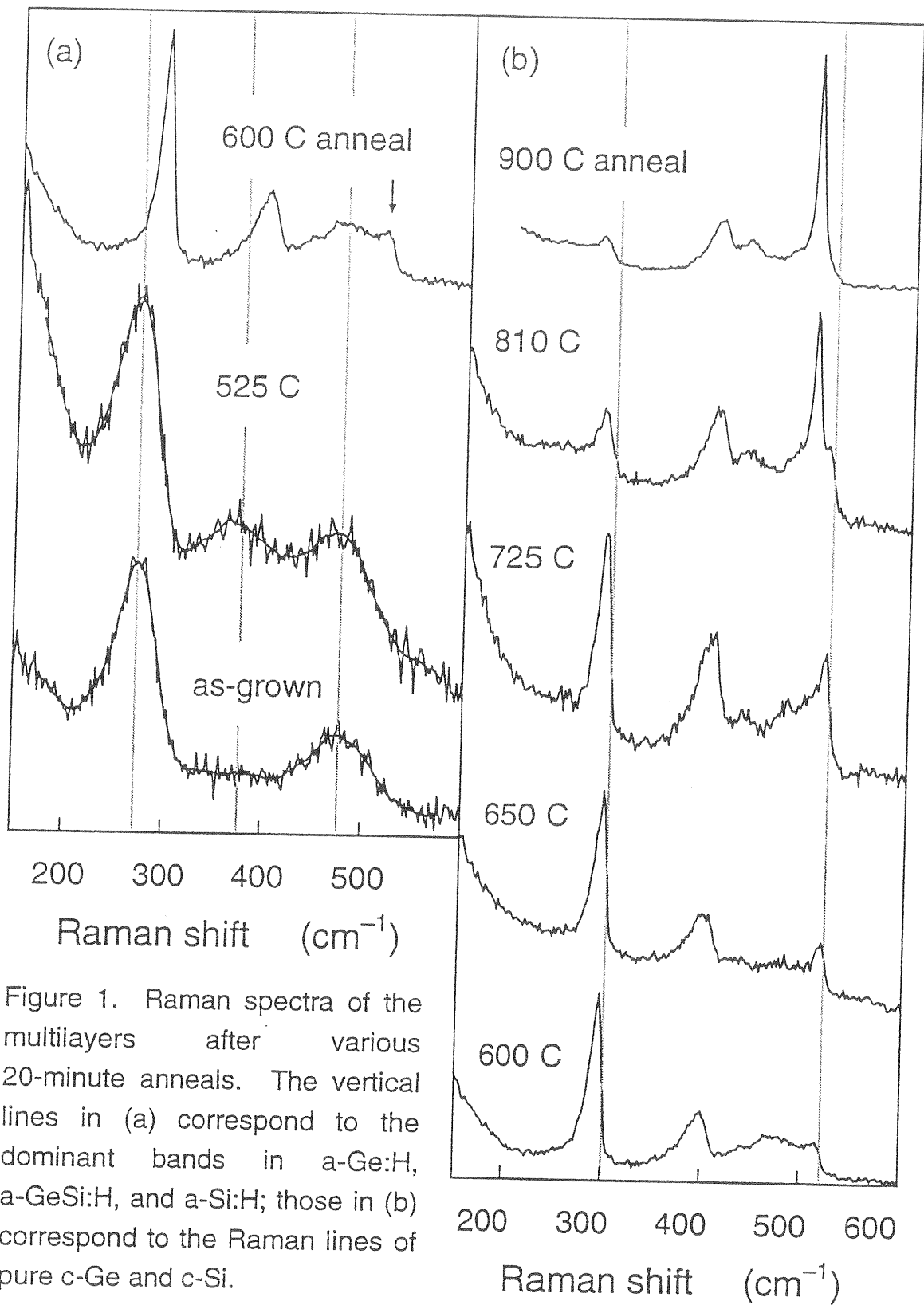
$$\bar{\nu}(\text{Si-Si}) = 521 - 62x - 11x^2, \quad x = 0.016\Delta - 0.000034\Delta^2, \quad (1)$$

$$\bar{\nu}(\text{Ge-Ge}) = 301 - 31y + 17y^2, \quad y = 0.025\delta + 0.0018\delta^2, \quad (2)$$

where x is the Ge fraction, $y=1-x$ is the Si fraction, $\bar{\nu}$ is in cm^{-1} , $\Delta=521-\bar{\nu}(\text{Si-Si})$, and $\delta=301-\bar{\nu}(\text{Ge-Ge})$. These relations are our fits to the c-Si_yGe_x room-temperature data of Refs. 4 and 5; they provide a convenient method for estimating x and y . The estimate based on (1) is the more reliable one, since $\bar{\nu}(\text{Si-Si})$ shifts quickly and nearly linearly

Table 1. Raman peak positions and linewidths, in cm^{-1} , and layer-composition estimates.

Anneal Temp.	Si-Si band		Si-Ge band		Ge-Ge band		x of "Si layer"	y of "Ge layer"
	$\bar{\nu}$	FWHM	$\bar{\nu}$	FWHM	$\bar{\nu}$	FWHM		
as-grown	477	65	—	—	272	46	0	0
525 C	477	79	376	66	270	47		
600 C	475	76						
	517	15	399	26	296	15	0.06	0.2
650 C	518	13	399	28	296	14	0.05	0.2
725 C	517	15	403	30	294	15	0.06	0.3
810 C	503	11	405	24	288	18	0.28	0.6
900 C	502	8	403	23	284	15	0.29	0.9



with x . The crystalline alloys also display^{4,5} a composition-insensitive narrow band near 400 cm^{-1} ; this Si-Ge band is present in our spectra for 600 C and above.

The position and sharpness of the Ge-Ge and Si-Ge lines seen for the 600 C anneal show that the Ge-rich layers are crystalline, and $\bar{\nu}(\text{Ge-Ge})$ indicates, via (2), that the composition is about $\text{Si}_{0.2}\text{Ge}_{0.8}$. Note that we can be confident, from (1), that the weak sharp line at 517 cm^{-1} does not arise from Si-Si vibrations in the $x=0.8$ Ge-rich layers, but instead arises from a small crystalline component in the Si-rich layers. This is confirmed by the growth of this line at higher anneals of 650 C and 725 C. The composition of these layers, from $\bar{\nu}(\text{Si-Si})$ and (1), is about $\text{Si}_{0.94}\text{Ge}_{0.06}$.

Figure 1 and Table 1 show that at 650 C and 725 C, the crystallization of the Si-rich layers proceeds while the layer compositions change little. At 810 C and 900 C, the shifted sharp lines signal composition changes, and Table 1 indicates that $x+y$ is now roughly unity (the y estimate is uncertain for large y). We interpret these results to represent the homogenization of the multilayer. In fact, our 900 C anneal spectrum is essentially identical to that reported, in Fig. 1(b) of Ref. 4, for $c\text{-Si}_{0.72}\text{Ge}_{0.28}$. This composition is Ge-rich relative to that corresponding to complete intermixing of the original superlattice ($\text{Si}_{0.86}\text{Ge}_{0.14}$); we attribute this to rejection of Ge from the silicon oxide surface layer expected for this high-temperature anneal.

4. Summary

The spectral signatures documented in Fig. 1 and Table 1 clearly demonstrate the compositional and structural changes which occur as a result of annealing-induced diffusion and crystallization. The intermediate structure arrived at in the 600 C anneal was close to a crystal/glass superlattice with alternating Ge-rich crystalline and Si-rich amorphous layers.

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 9. For both a-Si and a-Ge, H-depleted amorphous phases which could occur at modest anneals, (d_{opt}/d) is about 2.3.
 10. We assume the scattering efficiency of a- $\text{Si}_{0.5}\text{Ge}_{0.5}\text{:H}$ to be half that of a-Ge:H, and correct for the difference between measured spectra (our Fig. 1) and reduced Raman (Ref. 1).

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